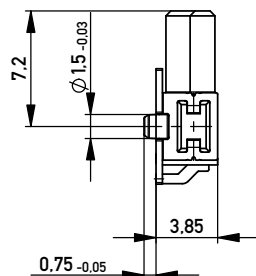
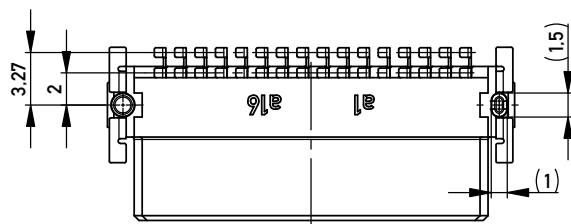
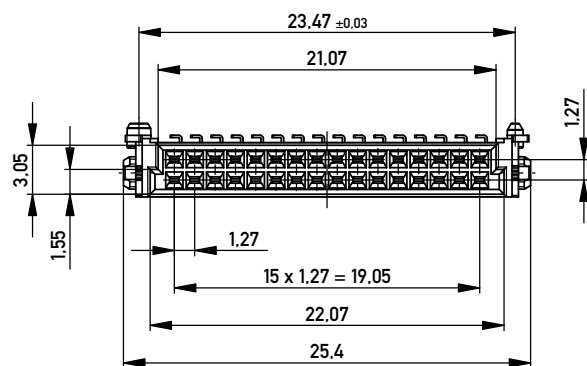
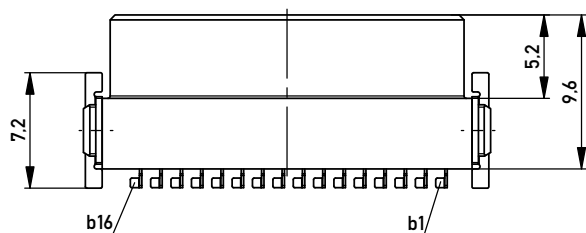
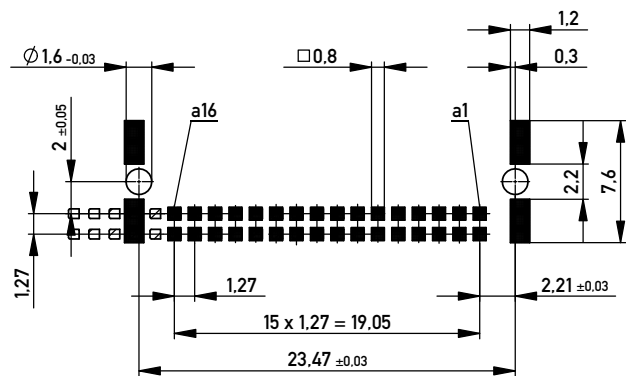


Leiterplatten-Layout Vorschlag für SMT  
PCB-Layout Proposal for SMT



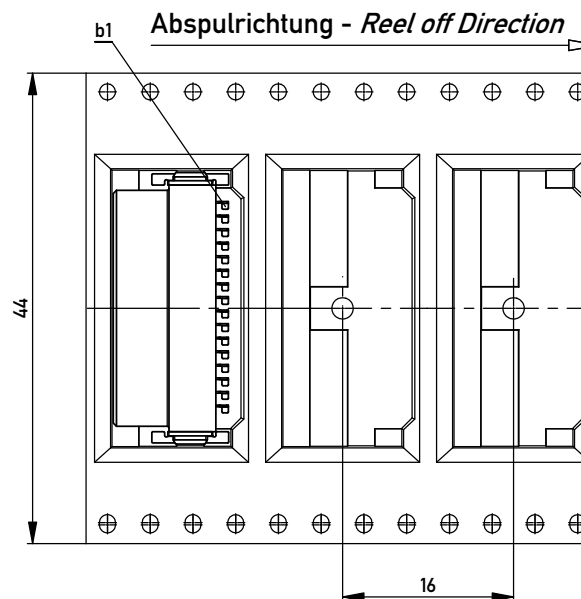
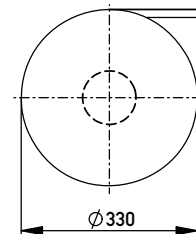
Anforderungsstufe 1  
Performance Level 1

Kontaktbereich vergoldet  
Mating Area gold plating

Anschlussbereich verzinkt 4-6  $\mu\text{m}$   
Terminal Area 4-6  $\mu\text{m}$  tin plating



Koplanarität der Anschlüsse  $\leq 0.1 \text{ mm}$   
Coplanarity Area of Termination  $\leq 0.1 \text{ mm}$

Verpackt im Gurt nach DIN IEC 60286-3  
Tape on Reel Packaging according to DIN IEC 60286-3  
Verpackungseinheit: 560 Stück  
Packaging unit: 560 pcs



BA7-03 - Standard Bauhöhe

type7-03 - standard assembly height

Information:		Tolerances	 All Dimensions in mm	Scale	3:1
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		www.ERNI.com		<b>354080</b>	
b	22.04.2014			I	
Index	Date			A3	
				Class	SMCQ

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